700V 7A N-Channel Enhancement Mode Power MOSFET

General Description

BXP7N70 is Bridgelux high voltage MOSFET family based on advanced planar stripe DMOS technology. This advanced MOSFET family has optimized on-state resistance, and also provides superior switching performance and higher avalanche energy strength. This device family is suitable for high efficiency switch mode power supplies.

SYMBOL









TO-252

TO-220 TO-220F

FEATURES

• RDSON≤1.5 Ω @Vgs=10V, Id=3.5A

• Excellent RDS(ON) and Low Gate Charge

· Fast switching capability

· Lead free product is acquired

ASSEMBLY MESSAGE

Product Name	Marking	Package	Packaging		
BXP7N70U	BXP7N70U	TO-251L	Tube		
BXP7N70D	BXP7N70D	TO-252	Tube/Reel		
BXP7N70P	BXP7N70P	TO-220	Tube		
BXP7N70F	BXP7N70F	TO-220F	Tube		

ABSOLUTE MAXIMUM RATINGS (T_c=25°C unless otherwise noted)

Parameter		Symbol	Rating			Unit
		Symbol	BXP7N70U/D	BXP7N70P	BXP7N70F	Unit
Drain-Source Voltage		V _{DSS}	700			V
Drain Current	Continuous (T _c = 25°C)		7			A
Drain Current	Continuous (T _C = 100°C)		4.1			Α
Drain Current	Pulsed (Note1)	I _{DM}	28			A
Gate-Source Voltage		V _{GSS}	±30			V
	Single Pulse (Note2)	E _{AS}	441			mJ
Avalanche Energy	Repetitive (Note1)	E _{AR}	21			mJ
Avalanche Current (Note1)		I _{AR}	7			Α
Peak Diode Recovery dv/dt (Note3)		dv/dt	5			V/ns
Power Dissipation (Note	T _C =25°C	Р	114	130	38	W
2)	Derate above 25°C	- P _D	0.912	1.04	0.304	W/°C
Maximum Junction Temperature		TJ	150			°C
Storage Temperature Range		T _{STG}	-55 to 150			°C

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L=18mH, V_{DD}=50V, RG=25 Ω , Starting TJ = 25°C

3. I_{SD} \leq 7.0A, di/dt \leq 100A/µs, V_{DD} \leq BV_{DSS}, Starting TJ = 25°C



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THERMAL CHARACTERISTICS

Parameter	Symbol	Max.			Unit	
Falameter	Symbol	BXP7N70U/D	BXP7N70P	BXP7N70F	Unit	
Thermal Resistance, Junction-to-Case	R _{θJC}	1.1	0.96	3.3	°C / W	
Thermal Resistance, Junction-to-Ambient R ₀ ,		62.5	62.5	120	°C / W	

ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise Noted)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS		1				1
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V, ID=250µA	700			V
		VDS=700V, VGS=0V			1	uA
Zero Gate Voltage Drain Current	IDSS	VDS=560V, TC = 125°C			100	uA
Gate-Body Leakage Current, Forward		VGS=30V			100	nA
Gate-Body Leakage Current, Reverse	– I _{GSS}	VGS=-30V			-100	nA
Breakdown Voltage Temperature	∆BVDSS/			0.70		
Coefficient	∆TJ	ID = 250 μA		0.72		V/℃
ON CHARACTERISTICS		·				
Gate Threshold Voltage	V _{GS(TH)}	VDS=VGS, ID=250µA	2		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	VGS=10V, ID=3.5A		1.35	1.5	Ω
Forward Transconductance (Note4)	g fs	VDS = 50V, ID = 3.5A		7.5		S
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}			1610		pF
Output Capacitance	Coss	VDS=25V, VGS=0V,		110		pF
Reverse Transfer Capacitance	C _{RSS}	f=1.0MHz		4.5		pF
SWITCHING PARAMETERS		•				
Turn-ON Delay Time	t _{D(ON)}			24		ns
Turn-ON Rise Time	t _R	VDD=350V, ID=7 A, VGS =		16		ns
Turn-OFF Delay Time	t _{D(OFF)}	10V ,RG=10Ω		40		ns
Turn-OFF Fall-Time	t⊨	(Note4,5)		15		ns
Total Gate Charge(Note5)	Q _G	VDS =560V, VGS =10V, ID		25		nC
Gate Source Charge	Q _{GS}	=7A		6.1		nC
Gate Drain Charge	Q _{GD}	(Note4,5)		9		nC
SOURCE- DRAIN DIODE RATINGS	AND CHAR	ACTERISTICS				
Drain-Source Diode Forward Voltage	Vsd	IS=7A, VGS=0V			1.4	V
Diode Continuous Forward Current	ls				7	Α
Pulsed Drain-Source Current	lsм				28	Α
Reverse Recovery Time	t _{RR}	VGS = 0 V, ISD = 7A		320		ns
Reverse Recovery Charge	Q _{RR}	di/dt=100 A/µs (Note4,5)		2.7		uC

Note: 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2%

5. Essentially independent of operating temperature



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Halogen Free

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TYPICAL CHARACTERISTICS

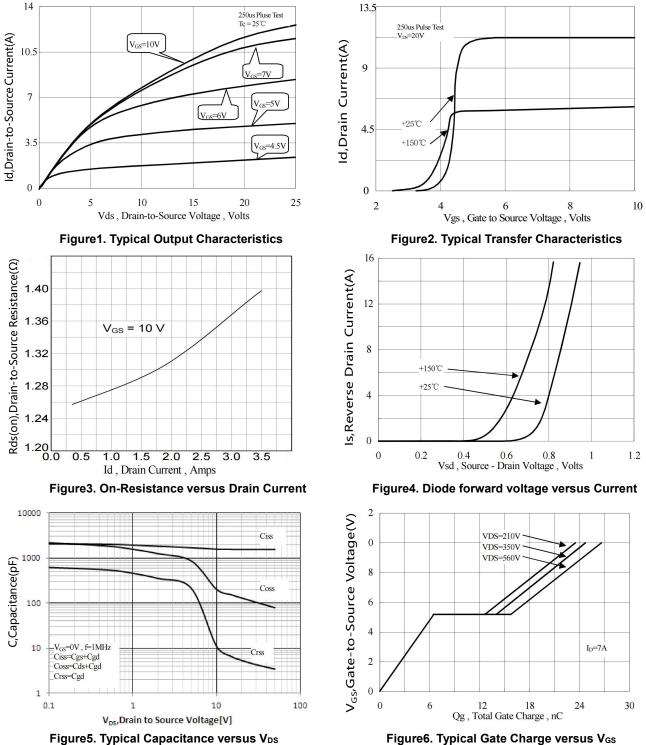
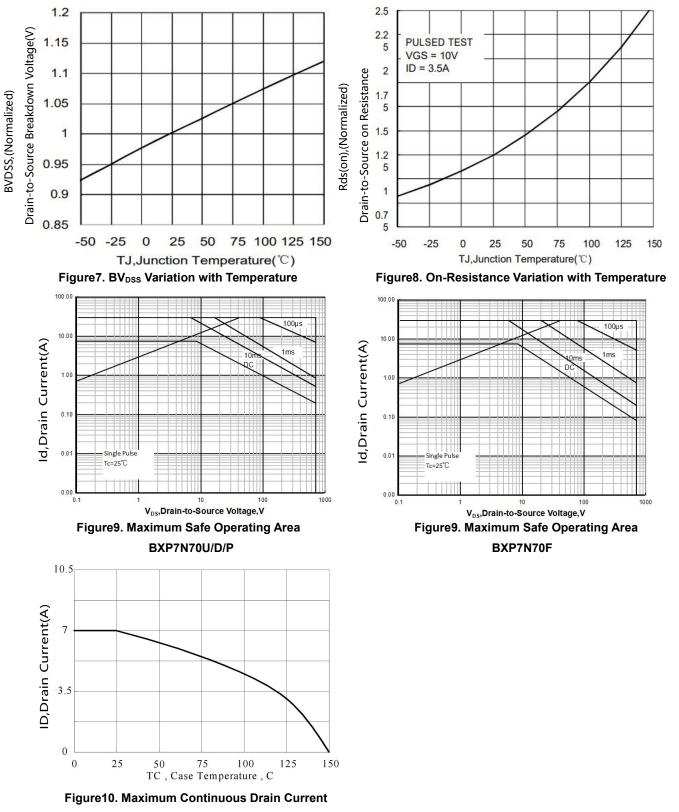


Figure6. Typical Gate Charge versus V_{GS}



TYPICAL CHARACTERISTICS(Cont.)



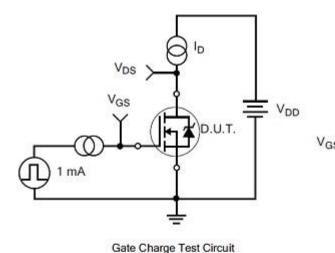
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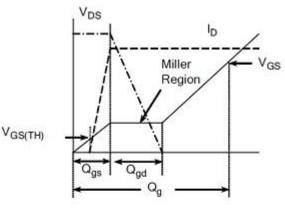
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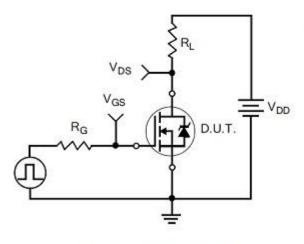
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TEST CIRCUITS AND WAVEFORMS

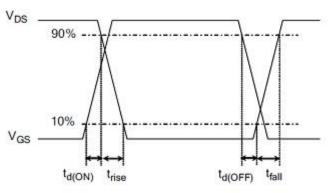




Gate Charge Waveform



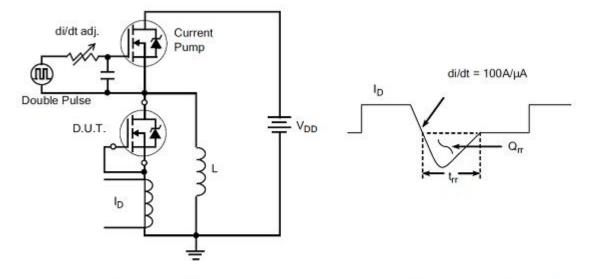
Resistive Switching Test Circuit



Resistive Switching Waveforms

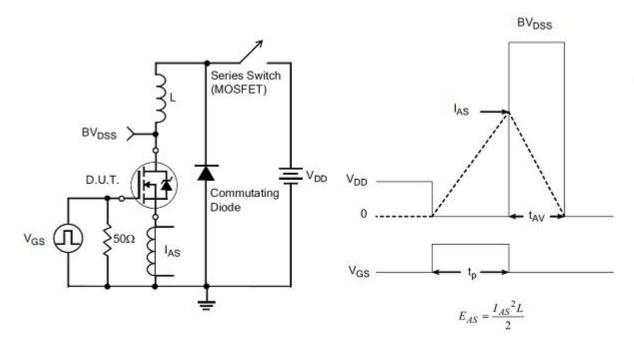
BXP7N70

TEST CIRCUITS AND WAVEFORMS(Cont.)



Diode Reverse Recovery Test Circuit

Diode Reverse Recovery Waveform



Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms





Revision history

Document revision history

Date	Revision	Changes
12-Oct-2021	1.0	First release
5-Jan-2022	1.1	Update parameter

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